Low-power Schmitt trigger inverter Rev. 6 — 28 June 2012

Product data sheet

General description 1.

The 74AUP1G14 provides a single inverting Schmitt trigger which accepts standard input signals. It is capable of transforming slowly changing input signals into sharply defined, jitter-free output signals.

This device ensures a very low static and dynamic power consumption across the entire V_{CC} range from 0.8 V to 3.6 V.

This device is fully specified for partial Power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

The inputs switch at different points for positive and negative-going signals. The difference between the positive voltage V_{T+} and the negative voltage V_{T-} is defined as the input hysteresis voltage V_H.

Features and benefits 2.

- Wide supply voltage range from 0.8 V to 3.6 V
- High noise immunity
- ESD protection:
 - HBM JESD22-A114F Class 3A exceeds 5000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Low static power consumption; $I_{CC} = 0.9 \,\mu A$ (maximum)
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V_{CC}
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

Applications 3.

- Wave and pulse shaper
- Astable multivibrator
- Monostable multivibrator



Low-power Schmitt trigger inverter

4. Ordering information

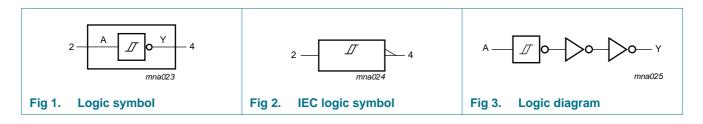
Table 1. Orderin	ng information			
Type number	Package			
	Temperature range	Name	Description	Version
74AUP1G14GW	–40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	SOT353-1
74AUP1G14GM	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1.45 \times 0.5 mm	SOT886
74AUP1G14GF	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1 \times 0.5 mm	SOT891
74AUP1G14GN	–40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body $0.9 \times 1.0 \times 0.35$ mm	SOT1115
74AUP1G14GS	–40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body $1.0 \times 1.0 \times 0.35$ mm	SOT1202
74AUP1G14GX	–40 °C to +125 °C	X2SON5	X2SON5: plastic thermal enhanced extremely thin small outline package; no leads; 5 terminals; body $0.8 \times 0.8 \times 0.35$ mm	SOT1226

5. Marking

Table 2. Marking	
Type number	Marking code ^[1]
74AUP1G14GW	pF
74AUP1G14GM	pF
74AUP1G14GF	pF
74AUP1G14GN	pF
74AUP1G14GS	pF
74AUP1G14GX	pF

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

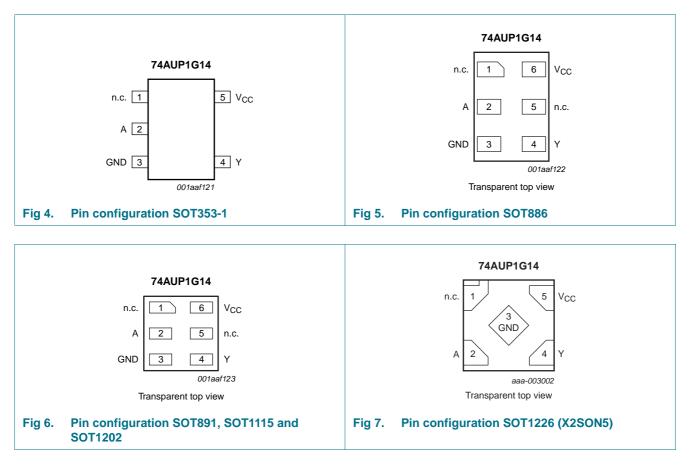
6. Functional diagram



Low-power Schmitt trigger inverter

7. Pinning information

7.1 Pinning



7.2 Pin description

Table 3.	Pin description		
Symbol	Pin		Description
	TSSOP5 and X2SON5	XSON6	
n.c.	1	1	not connected
А	2	2	data input
GND	3	3	ground (0 V)
Y	4	4	data output
n.c.	-	5	not connected
V _{CC}	5	6	supply voltage

74AUP1G14 Product data sheet

Functional description 8.

Table 4. Function table ^[1]	
Input	Output
Α	Y
L	Н
Н	L

[1] H = HIGH voltage level;

L = LOW voltage level.

Limiting values 9.

Table 5. **Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Мах	Unit
V _{CC}	supply voltage		-0.5	+4.6	V
I _{IK}	input clamping current	V ₁ < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
I _{OK}	output clamping current	V _O < 0 V	-50	-	mA
Vo	output voltage	Active mode and Power-down mode	<u>[1]</u> –0.5	+4.6	V
lo	output current	$V_{O} = 0 V \text{ to } V_{CC}$	-	±20	mA
I _{CC}	supply current		-	+50	mA
I _{GND}	ground current		-50	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C$ to +125 $^{\circ}C$	[2] _	250	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For TSSOP5 packages: above 87.5 °C the value of Ptot derates linearly with 4.0 mW/K.

For XSON6 and X2SON5 packages: above 118 °C the value of Ptot derates linearly with 7.8 mW/K.

10. Recommended operating conditions

Table 6.	Recommended operating cond	litions			
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		0.8	3.6	V
VI	input voltage		0	3.6	V
Vo	output voltage	Active mode	0	V_{CC}	V
		Power-down mode; $V_{CC} = 0 V$	0	3.6	V
T _{amb}	ambient temperature		-40	+125	°C

11. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = 2	5 °C					
V _{OH}	HIGH-level output voltage	$V_I = V_{T+}$ or V_{T-}				
		I_O = –20 $\mu\text{A};V_{CC}$ = 0.8 V to 3.6 V	$V_{CC}-0.1$	-	-	V
		$I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	$0.75 imes V_{CC}$	-	-	V
		$I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	1.11	-	-	V
		$I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.32	-	-	V
		$I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	2.05	-	-	V
		$I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.9	-	-	V
		$I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.72	-	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.6	-	-	V
V _{OL}	LOW-level output voltage	$V_I = V_{T+}$ or V_{T-}				
		$I_O = 20 \ \mu\text{A}; \ V_{CC} = 0.8 \ V \text{ to } 3.6 \ V$	-	-	0.1	V
		I _O = 1.1 mA; V _{CC} = 1.1 V	-	-	$0.3 \times V_{\text{CC}}$	V
		I _O = 1.7 mA; V _{CC} = 1.4 V	-	-	0.31	V
		I _O = 1.9 mA; V _{CC} = 1.65 V	-	-	0.31	V
		$I_0 = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.31	V
		I _O = 3.1 mA; V _{CC} = 2.3 V	-	-	0.44	V
		I_{O} = 2.7 mA; V_{CC} = 3.0 V	-	-	0.31	V
		$I_0 = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.44	V
l _l	input leakage current	V_I = GND to 3.6 V; V_{CC} = 0 V to 3.6 V	-	-	±0.1	μΑ
I _{OFF}	power-off leakage current	V_{I} or V_{O} = 0 V to 3.6 V; V_{CC} = 0 V	-	-	±0.2	μA
ΔI_{OFF}	additional power-off leakage current	$V_{I} \text{ or } V_{O} = 0 \text{ V to } 3.6 \text{ V;}$ $V_{CC} = 0 \text{ V to } 0.2 \text{ V}$	-	-	±0.2	μA
I _{CC}	supply current	$V_I = GND \text{ or } V_{CC}; I_O = 0 \text{ A};$ $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	0.5	μA
ΔI _{CC}	additional supply current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{CC} - 0.6 \; V; \; I_{O} = 0 \; A; \\ V_{CC} = 3.3 \; V \end{array}$	-	-	40	μA
CI	input capacitance	V_{I} = GND or V_{CC} ; V_{CC} = 0 V to 3.6 V	-	1.1	-	pF
Co	output capacitance	$V_{O} = GND; V_{CC} = 0 V$	-	1.7	-	pF
T _{amb} = –	40 °C to +85 °C					
V _{он}	HIGH-level output voltage	$V_{I} = V_{T+}$ or V_{T-}				
		$I_{O} = -20 \ \mu\text{A}; \ V_{CC} = 0.8 \ V \ \text{to} \ 3.6 \ V$	V _{CC} – 0.1	-	-	V
		I _O = -1.1 mA; V _{CC} = 1.1 V	$0.7 \times V_{CC}$	-	-	V
		I _O = -1.7 mA; V _{CC} = 1.4 V	1.03	-	-	V
		$I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.30	-	-	V
		$I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.97	-	-	V
		$I_0 = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.85	-	-	V
		$I_{O} = -2.7 \text{ mA; } V_{CC} = 3.0 \text{ V}$	2.67	-	-	V
		$I_{\rm O} = -4.0$ mA; $V_{\rm CC} = 3.0$ V	2.55	-	-	V
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74AUP1G14

Low-power Schmitt trigger inverter

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{OL}	LOW-level output voltage	$V_I = V_{T+}$ or V_{T-}				
		I_O = 20 μ A; V_{CC} = 0.8 V to 3.6 V	-	-	0.1	V
		I _O = 1.1 mA; V _{CC} = 1.1 V	-	-	$0.3 \times V_{CC}$	V
		I _O = 1.7 mA; V _{CC} = 1.4 V	-	-	0.37	V
		I _O = 1.9 mA; V _{CC} = 1.65 V	-	-	0.35	V
		$I_0 = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.33	V
		I _O = 3.1 mA; V _{CC} = 2.3 V	-	-	0.45	V
		$I_{O} = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.33	V
		I _O = 4.0 mA; V _{CC} = 3.0 V	-	-	0.45	V
l	input leakage current	$V_{I} = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V	-	-	±0.5	μA
I _{OFF}	power-off leakage current	$V_1 \text{ or } V_0 = 0 \text{ V to } 3.6 \text{ V; } V_{CC} = 0 \text{ V}$	-	-	±0.5	μA
ΔI_{OFF}	additional power-off leakage current	$V_{I} \text{ or } V_{O} = 0 \text{ V to } 3.6 \text{ V;}$ $V_{CC} = 0 \text{ V to } 0.2 \text{ V}$	-	-	±0.6	μA
I _{CC}	supply current	$V_I = GND \text{ or } V_{CC}; I_O = 0 \text{ A};$ $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	0.9	μA
ΔI_{CC}	additional supply current		-	-	50	μΑ
T _{amb} = –	40 °C to +125 °C					
V _{ОН}	HIGH-level output voltage	$V_I = V_{T+}$ or V_{T-}				
		I_{O} = -20 μ A; V_{CC} = 0.8 V to 3.6 V	V _{CC} – 0.11	-	-	V
		I _O = -1.1 mA; V _{CC} = 1.1 V	$0.6 imes V_{CC}$	-	-	V
		$I_0 = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	0.93	-	-	V
		I _O = -1.9 mA; V _{CC} = 1.65 V	1.17	-	-	V
		$I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.77	-	-	V
		$I_0 = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.67	-	-	V
		$I_0 = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.40	-	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.30	-	-	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{T+}$ or V_{T-}				
		I_{O} = 20 μ A; V_{CC} = 0.8 V to 3.6 V	-	-	0.11	V
		I _O = 1.1 mA; V _{CC} = 1.1 V	-	-	$0.33 imes V_{CC}$	V
		I _O = 1.7 mA; V _{CC} = 1.4 V	-	-	0.41	V
		I _O = 1.9 mA; V _{CC} = 1.65 V	-	-	0.39	V
		$I_0 = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.36	V
		$I_0 = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.50	V
		$I_0 = 2.7 \text{ mA; } V_{CC} = 3.0 \text{ V}$	-	-	0.36	V
		$I_0 = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.50	v
lı	input leakage current	$V_{I} = GND \text{ to } 3.6 \text{ V}; V_{CC} = 0 \text{ V to } 3.6 \text{ V}$	-	-	±0.75	μA
.1					_0.10	P

Static characteristics ... continued Table 7.

Low-power Schmitt trigger inverter

At recom	mended operating conditions;	voltages are referenced to GND (ground	I = 0 V).			
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
ΔI_{OFF}	additional power-off leakage current	$ V_{I} \text{ or } V_{O} = 0 \text{ V to } 3.6 \text{ V}; $	-	-	±0.75	μΑ
I _{CC}	supply current	$V_{I} = GND \text{ or } V_{CC}; I_{O} = 0 \text{ A};$ $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	1.4	μA
ΔI_{CC}	additional supply current		-	-	75	μA

Table 7. Static characteristics ...continued

12. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9.

Symbol	Parameter	Conditions			25 °C		-4	0 °C to +1	25 °C	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max (85 °C)	Max (125 °C)	
C _L = 5 pl	F	1				1	I			
t _{pd}	propagation delay	A to Y; see Figure 8	[2]							
		$V_{CC} = 0.8 V$		-	19.9	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V		2.7	5.9	11.0	2.4	11.1	11.2	ns
		V_{CC} = 1.4 V to 1.6 V		2.6	4.3	6.6	2.4	7.1	7.4	ns
		V_{CC} = 1.65 V to 1.95 V		2.1	3.7	5.4	2.0	6.0	6.2	ns
		V_{CC} = 2.3 V to 2.7 V		2.0	3.0	4.1	1.7	4.5	4.7	ns
		V_{CC} = 3.0 V to 3.6 V		1.9	2.8	3.6	1.5	3.9	4.0	ns
C _L = 10	pF									
pd	propagation delay	A to Y; see Figure 8	[2]							
		$V_{CC} = 0.8 V$		-	23.4	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V		2.9	6.8	12.7	2.8	12.8	12.9	ns
		V_{CC} = 1.4 V to 1.6 V		2.8	5.0	7.7	2.6	8.2	8.6	ns
		V_{CC} = 1.65 V to 1.95 V		2.7	4.2	6.2	2.5	6.7	7.1	ns
		V_{CC} = 2.3 V to 2.7 V		2.3	3.6	4.8	2.1	5.2	5.5	ns
		V_{CC} = 3.0 V to 3.6 V		2.1	3.3	4.3	2.0	4.5	4.7	ns
C _L = 15	pF									
t _{pd}	propagation delay	A to Y; see Figure 8	[2]							
		$V_{CC} = 0.8 V$		-	26.9	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V		3.3	7.6	14.3	3.0	14.5	14.7	ns
		V_{CC} = 1.4 V to 1.6 V		3.3	5.5	8.6	2.9	9.4	9.8	ns
		V_{CC} = 1.65 V to 1.95 V		2.8	4.7	7.0	2.8	7.7	8.1	ns
		V_{CC} = 2.3 V to 2.7 V		2.7	4.0	5.5	2.4	5.9	6.2	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		2.6	3.8	4.8	2.2	5.2	5.4	ns

$C_L = 30 \text{ pF}$

Low-power Schmitt trigger inverter

Symbol	Parameter	Conditions		25 °C		-4	10 °C to +1	25 °C	Unit
			Mi	n Typ <mark>[1]</mark>	Max	Min	Max (85 °C)	Max (125 °C)	
t _{pd}	propagation delay	A to Y; see Figure 8	[2]						
		$V_{CC} = 0.8 V$	-	37.3	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	4.(9.8	18.7	3.9	19.6	20.0	ns
		V_{CC} = 1.4 V to 1.6 V	3.7	7.1	11.2	3.8	12.3	12.9	ns
		V_{CC} = 1.65 V to 1.95 V	3.6	6.0	9.1	3.6	10.0	10.6	ns
		V_{CC} = 2.3 V to 2.7 V	3.5	5 5.2	6.9	3.2	7.5	7.9	ns
		V_{CC} = 3.0 V to 3.6 V	3.3	4.8	6.1	3.1	7.1	7.4	ns
C _L = 5 p	F, 10 pF, 15 pF and	30 pF							
C _{PD}	power dissipation	$f_i = 1 \text{ MHz}; V_I = \text{GND to } V_{CC}$	[3]						
	capacitance	$V_{CC} = 0.8 V$	-	2.6	-	-	-	-	pF
		V_{CC} = 1.1 V to 1.3 V	-	2.7	-	-	-	-	pF
		V_{CC} = 1.4 V to 1.6 V	-	2.9	-	-	-	-	pF
		V_{CC} = 1.65 V to 1.95 V	-	3.1	-	-	-	-	pF
		V_{CC} = 2.3 V to 2.7 V	-	3.7	-	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	4.3	-	-	-	-	pF

Table 8. Dynamic characteristics ... continued

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9.

[1] All typical values are measured at nominal V_{CC} .

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

 $f_o = output frequency in MHz;$

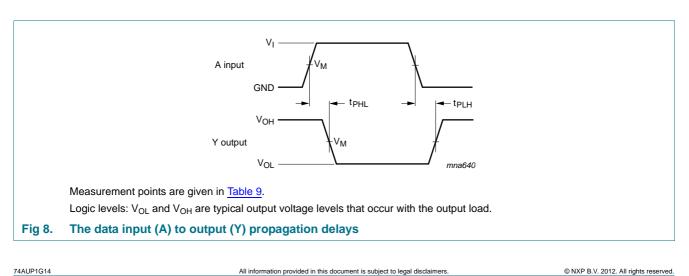
C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

13. Waveforms



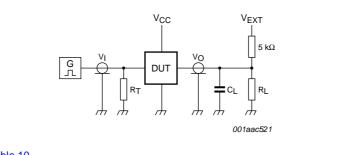
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Low-power Schmitt trigger inverter

Supply voltage	Output	Input			
V _{CC}	V _M	V _M	VI	$t_r = t_f$	
0.8 V to 3.6 V	$0.5 \times V_{CC}$	$0.5 imes V_{CC}$	V _{CC}	≤ 3.0 ns	



Test data is given in <u>Table 10</u>. Definitions for test circuit:

 R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to the output impedance Z_o of the pulse generator.

 V_{EXT} = External voltage for measuring switching times.

Fig 9. Load circuitry for switching times

Table 10. Test data

Supply voltage	Load		V _{EXT}		
V _{CC}	CL	R _L [1]	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
0.8 V to 3.6 V	5 pF, 10 pF, 15 pF and 30 pF	5 k Ω or 1 M Ω	open	GND	$2 \times V_{CC}$

[1] For measuring enable and disable times $R_L = 5 k\Omega$, for measuring propagation delays, setup and hold times and pulse width $R_L = 1 M\Omega$.

14. Transfer characteristics

Table 11. Transfer characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = 25 °	O °					
V _{T+} positive-going threshold voltage		see Figure 10 and Figure 11				
	threshold voltage	$V_{CC} = 0.8 V$	0.30	-	0.60	V
		$V_{CC} = 1.1 V$	0.53	-	0.90	V
		$V_{CC} = 1.4 V$	0.74	-	1.11	V
		V _{CC} = 1.65 V	0.91	-	1.29	V
		$V_{CC} = 2.3 V$	1.37	-	1.77	V
		$V_{CC} = 3.0 V$	1.88	-	2.29	V

Low-power Schmitt trigger inverter

Table 11. Transfer characteristics ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit see <u>Figure 9</u>.

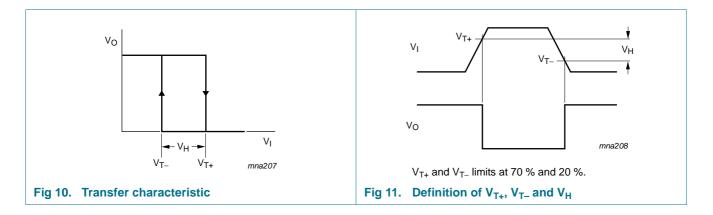
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{T-}	negative-going	see Figure 10 and Figure 11				
	threshold voltage	$V_{CC} = 0.8 V$	0.10	-	0.60	V
		V _{CC} = 1.1 V	0.26	-	0.65	V
		$V_{CC} = 1.4 V$	0.39	-	0.75	V
		V _{CC} = 1.65 V	0.47	-	0.84	V
		$V_{CC} = 2.3 V$	0.69	-	1.04	V
		$V_{CC} = 3.0 V$	0.88	-	1.24	V
V _H	hysteresis voltage	see <u>Figure 10, Figure 11,</u> <u>Figure 12</u> and <u>Figure 13</u>				
		$V_{CC} = 0.8 V$	0.07	-	0.50	V
		V _{CC} = 1.1 V	0.08	-	0.46	V
		$V_{CC} = 1.4 V$	0.18	-	0.56	V
		V _{CC} = 1.65 V	0.27	-	0.66	V
		$V_{CC} = 2.3 V$	0.53	-	0.92	V
		$V_{CC} = 3.0 V$	0.79	-	1.31	V
T _{amb} = -40	°C to +85 °C					
V _{T+}	positive-going threshold voltage	see Figure 10 and Figure 11				
		$V_{CC} = 0.8 V$	0.30	-	0.60	V
		V _{CC} = 1.1 V	0.53	-	0.90	V
		$V_{CC} = 1.4 V$	0.74	-	1.11	V
		V _{CC} = 1.65 V	0.91	-	1.29	V
		$V_{CC} = 2.3 V$	1.37	-	1.77	V
		$V_{CC} = 3.0 V$	1.88	-	2.29	V
V _{T-}	negative-going threshold voltage	see Figure 10 and Figure 11				
		$V_{CC} = 0.8 V$	0.10	-	0.60	V
		$V_{CC} = 1.1 V$	0.26	-	0.65	V
		$V_{CC} = 1.4 V$	0.39	-	0.75	V
		V _{CC} = 1.65 V	0.47	-	0.84	V
		$V_{CC} = 2.3 V$	0.69	-	1.04	V
		$V_{CC} = 3.0 V$	0.88	-	1.24	V
V _H	hysteresis voltage	see <u>Figure 10, Figure 11,</u> <u>Figure 12</u> and <u>Figure 13</u>				
		$V_{CC} = 0.8 V$	0.07	-	0.50	V
		$V_{CC} = 1.1 V$	0.08	-	0.46	V
		$V_{CC} = 1.4 V$	0.18	-	0.56	V
		V _{CC} = 1.65 V	0.27	-	0.66	V
		$V_{CC} = 2.3 V$	0.53	-	0.92	V
		$V_{CC} = 3.0 V$	0.79	-	1.31	V

Low-power Schmitt trigger inverter

Voltages are	e referenced to GND (g	round = 0 V); for test circuit see <u>Figure</u>	<u>9</u> .			
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = -40	°C to +125 °C					
V _{T+}	positive-going threshold voltage	see Figure 10 and Figure 11				
		V _{CC} = 0.8 V	0.30	-	0.62	V
		V _{CC} = 1.1 V	0.53	-	0.92	V
		$V_{CC} = 1.4 V$	0.74	-	1.13	V
		V _{CC} = 1.65 V	0.91	-	1.31	V
		$V_{CC} = 2.3 V$	1.37	-	1.80	V
		$V_{CC} = 3.0 V$	1.88	-	2.32	V
V _{T-}	negative-going threshold voltage	see Figure 10 and Figure 11				
		$V_{CC} = 0.8 V$	0.10	-	0.60	V
		V _{CC} = 1.1 V	0.26	-	0.65	V
		$V_{CC} = 1.4 V$	0.39	-	0.75	V
		V _{CC} = 1.65 V	0.47	-	0.84	V
		$V_{CC} = 2.3 V$	0.69	-	1.04	V
		$V_{CC} = 3.0 V$	0.88	-	1.24	V
V _H	hysteresis voltage	see <u>Figure 10, Figure 11,</u> <u>Figure 12</u> and <u>Figure 13</u>				
		$V_{CC} = 0.8 V$	0.07	-	0.50	V
		V _{CC} = 1.1 V	0.08	-	0.46	V
		$V_{CC} = 1.4 V$	0.18	-	0.56	V
		V _{CC} = 1.65 V	0.27	-	0.66	V
		$V_{CC} = 2.3 V$	0.53	-	0.92	V
		$V_{CC} = 3.0 V$	0.79	-	1.31	V

Table 11. Transfer characteristics ... continued

15. Waveforms transfer characteristics

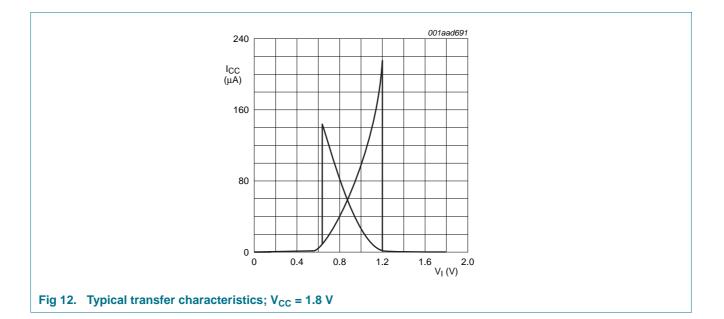


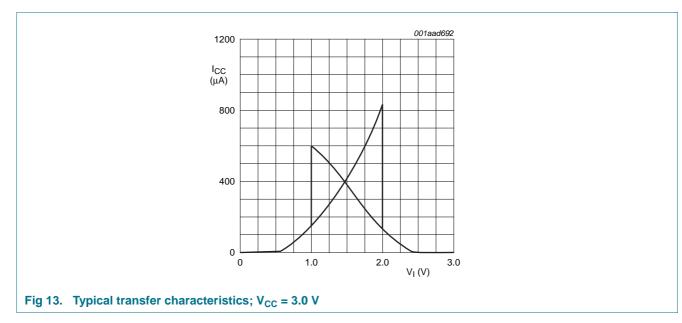
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Low-power Schmitt trigger inverter





16. Application information

The slow input rise and fall times cause additional power dissipation, this can be calculated using the following formula:

 $P_{ad} = f_i \times (t_r \times I_{CC(AV)} + t_f \times I_{CC(AV)}) \times V_{CC}$ where:

 P_{ad} = additional power dissipation (μ W);

 $f_i = input frequency (MHz);$

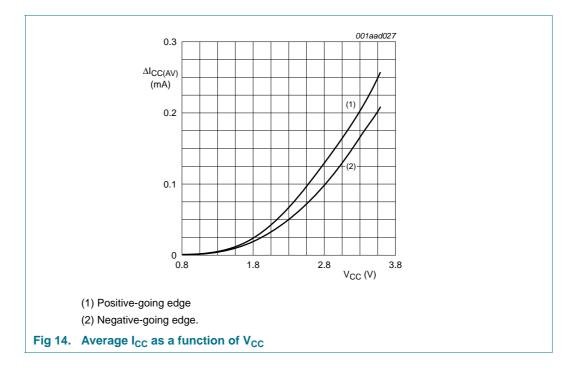
 t_r = input rise time (ns); 10 % to 90 %;

 t_f = input fall time (ns); 90 % to 10 %;

 $I_{CC(AV)}$ = average additional supply current (µA).

Average I_{CC} differs with positive or negative input transitions, as shown in Figure 14.

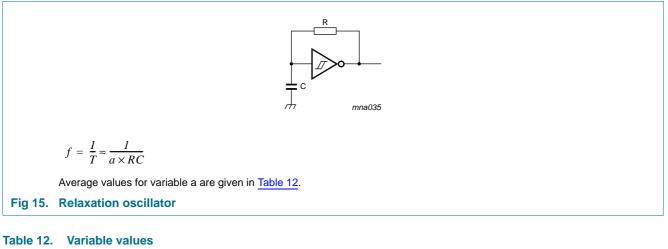
An example of a relaxation circuit using the 74AUP1G14 is shown in Figure 15.



NXP Semiconductors

74AUP1G14

Low-power Schmitt trigger inverter



Supply voltage	Variable a	
1.1 V	1.28	
1.5 V	1.22	
1.8 V	1.24	
2.8 V	1.34	
3.3 V	1.45	

Low-power Schmitt trigger inverter

17. Package outline

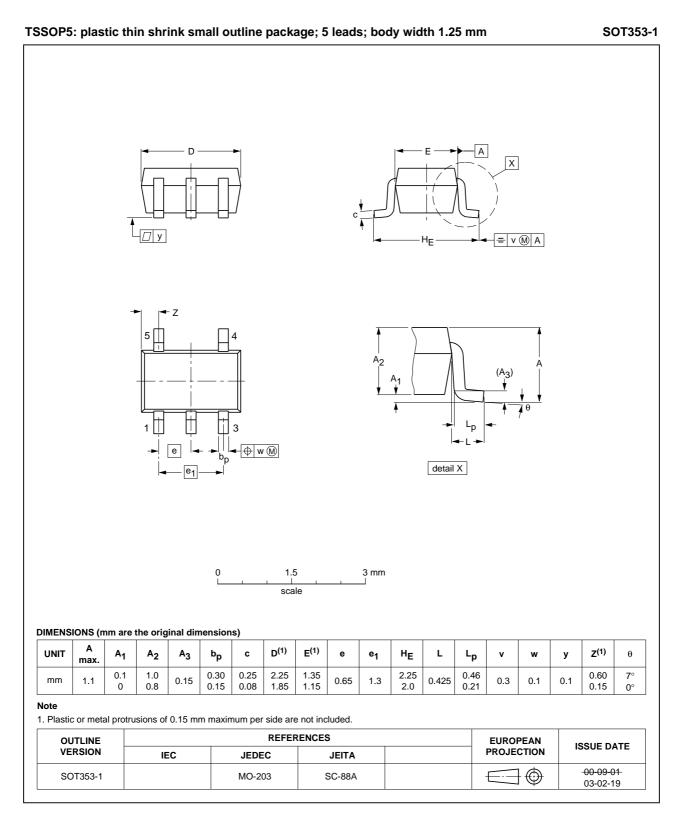


Fig 16. Package outline SOT353-1 (TSSOP5)

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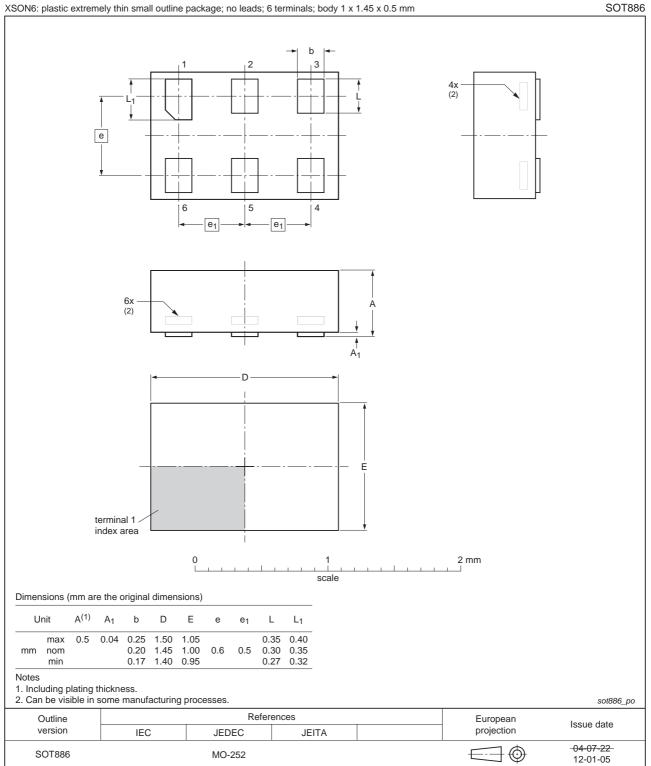


Fig 17. Package outline SOT886 (XSON6)

74AUP1G14 **Product data sheet**

Low-power Schmitt trigger inverter

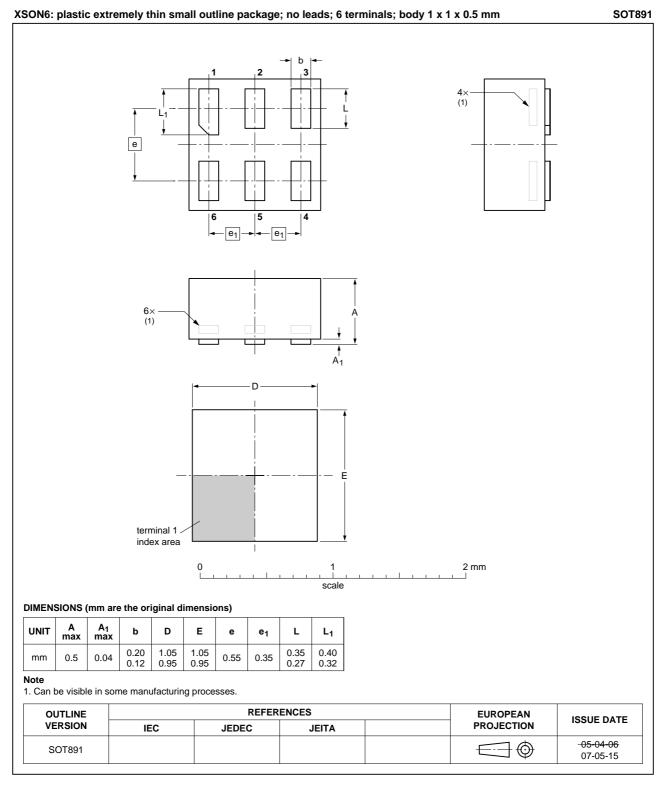
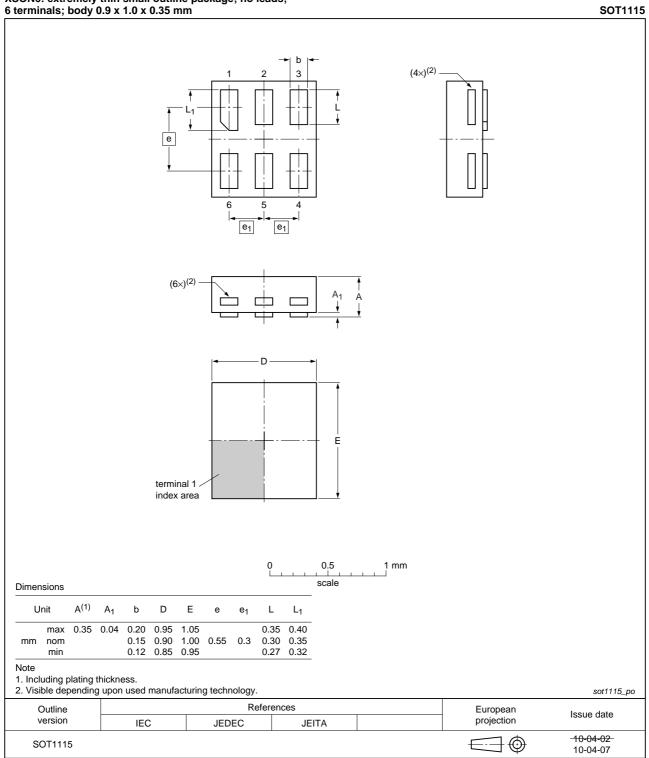


Fig 18. Package outline SOT891 (XSON6)

74AUP1G14 Product data sheet

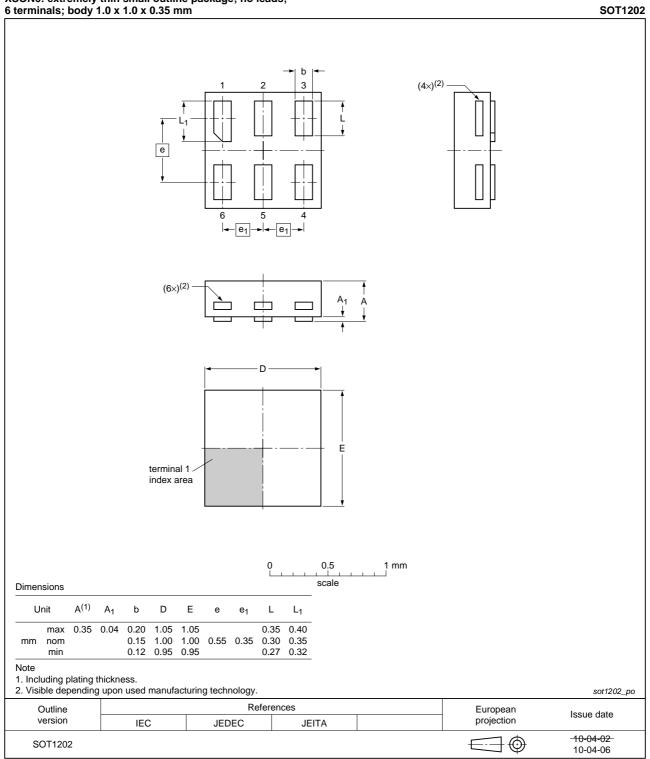
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XSON6: extremely thin small outline package; no leads; 6 terminals; body 0.9 x 1.0 x 0.35 mm

Fig 19. Package outline SOT1115 (XSON6)

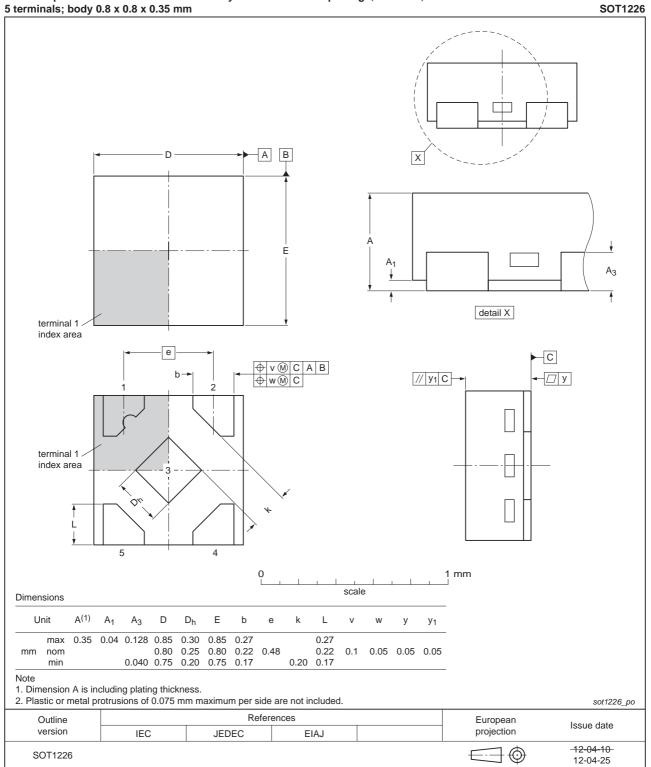
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XSON6: extremely thin small outline package; no leads; 6 terminals; body 1.0 x 1.0 x 0.35 mm

Fig 20. Package outline SOT1202 (XSON6)

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X2SON5: plastic thermal enhanced extremely thin small outline package; no leads; 5 terminals; body 0.8 x 0.8 x 0.35 mm

Fig 21. Package outline SOT1226 (X2SON5)

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18. Abbreviations

Table 13. A	bbreviations
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model

19. Revision history

Table 14. Revision	on history			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74AUP1G14 v.6	20120628	Product data sheet	-	74AUP1G14 v.5
Modifications:	 Added type n 	umber 74AUP1G14GX (SOT12	226)	
	 Package outl 	ine drawing of SOT886 (<mark>Figure</mark>	17) modified.	
74AUP1G14 v.5	20111128	Product data sheet	-	74AUP1G14 v.4
Modifications:	 Legal pages 	updated.		
74AUP1G14 v.4	20100713	Product data sheet	-	74AUP1G14 v.3
74AUP1G14 v.3	20090708	Product data sheet	-	74AUP1G14 v.2
74AUP1G14 v.2	20060828	Product data sheet	-	74AUP1G14 v.1
74AUP1G14 v.1	20050718	Product data sheet	-	-

20. Legal information

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Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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22. Contents

1	General description 1
2	Features and benefits 1
3	Applications 1
4	Ordering information 2
5	Marking 2
6	Functional diagram 2
7	Pinning information 3
7.1	Pinning 3
7.2	Pin description 3
8	Functional description 4
9	Limiting values 4
10	Recommended operating conditions 4
11	Static characteristics 5
12	Dynamic characteristics 7
13	Waveforms
14	Transfer characteristics 9
15	Waveforms transfer characteristics 11
16	Application information
17	Package outline 15
18	Abbreviations
19	Revision history
20	Legal information 22
20.1	Data sheet status 22
20.2	Definitions 22
20.3	Disclaimers 22
20.4	Trademarks
21	Contact information 23
22	Contents 24

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